

SIM card 6-pin

Contact bend prevention design Manual connector BER

Product Name: FMS006-5000-0



- Manual type
- ◆ Low profile design H=1.5mm
- Top mount
- Contact bend prevention design
- EMI prevention design
- RoHS compliant
- Pb-free soldering capable

Specification

Current Rating	0.5A
Voltage Rating	5V AC rms
Insulation Resistance	500MΩ Minimum at 500V DC
Withstanding Voltage	250V AC rms 1 minute
Contact Resistance	at 1mA/20mV Initial value : 100mΩ Max. Finished test : 40mΩ Max.
Operating Temperature	-25°C∼ +85°C
Durability	5,000cycles

Packing Quantity

1,000pcs/ Tape and Reel

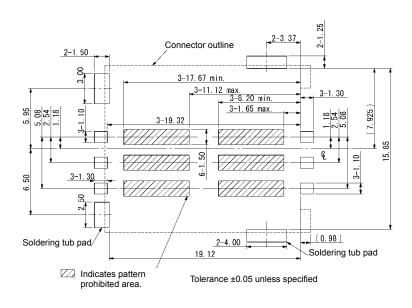
Material & Plating

Product Name	Material & Plating
Metal Shell Cover	SUS, Ni-Au
Insulator	Heat Resistance Plastic
Contact	Copper Alloy, Ni-Au

Outline Dimension

21.10 C3 - 🖃 ⊒-C7 ≨| 8 9 C2 - E -C1 -E ⊒-C5 20

Recommended Foot Pattern



* Please request latest drawing and specification when this P/N is considered to adopt. Inquiry: Yamaichi Electronics Co., Ltd. CS Business Planning Section TEL 03-3778-6160 • FAX 03-3778-6177

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